Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

/!\ REMINDERS

Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

*Notes:

- 1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

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Industrial Application Guide

The products described as "For Telecommunications Infrastructure and Industrial Equipment" in this catalog are intended for use in the equipment shown in the below table as its typical example. Therefore, when using our products for these equipment, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding products. Should you have any questions on this matter, please contact us.

Category	Telecommunications Infrastructure and Industrial Equipment (Typical Example)
Telecommunications Infrastructure	 Base Station Optical Transceiver Router/Switch (Carrier-Grade) UPS (Uninterruptible Power Supply), etc.
Factory Automation	PLC (Programmable Logic Controller)Servomotor/Servo DriverIndustry Robot, etc.
Measurement	 Gas Meter Water Meter Flow Meter Pressure Gauge Meter Magnetometer Thermometer, etc.
Electric Power Apparatus	 Power Conditioner (Solar Power System) Smart Meter GFCI (Ground Fault Circuit Interrupter) Electric Vehicle Charging Station, etc.

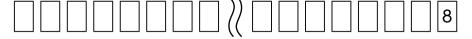
Part Numbering System

Multilayer Ceramic Capacitors:



If the 15th code from the left is "8", it indicates "For Telecommunications Infrastructure and Industrial Equipment" or "For Medical Devices".

Inductors:



If the 1st code from the right is "8" regardless of the total digit number, it indicates "For Telecommunications Infrastructure and Industrial Equipment" or "For Medical Devices".

Because there are some exceptions, for details please refer to each page of this catalog where the part numbering system of each product is described.

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Medical Application Guide

The products described as "For Medical Devices" in this catalog are intended for use in the medical devices classified as GHTF Classes A to C (Japan Classes I to III) except for all medical devices classified as GHTF Class D (Japan Class IV) and implantable medical devices (bone-anchored hearing aid, artificial retina system, and external unit which is connected to internal unit which is implanted in a body, etc.). Therefore, when using our products for these medical devices, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding products. Should you have any questions on this matter, please contact us.

Risk Level		Low					High			
	of Japan	Class I General Medical Devices (GHTF Class A)	Me (G	Class II Controlled dical Devices HTF Class B)	Class III Specially-conti Medical Dev (GHTF Class	rolled ices s C)	Class IV Specially-controlled Medical Devices (GHTF Class D)			
	PMD Act of . F Rules)	Medical devices with extremely low risk to the human body in case of problems	relativel	devices with y low risk to the body in case of s	Medical devices v relatively high risk human body in ca problems	to the	Medical devices highly invasive to patients and with life-threatening risk in case of problems			
Japan	Classification according to the I (based on the GHTF	[Ex.] In Vitro Diagnostic Devices Nebulizer Blood Gas Analyzer Plethysmographs Breathing Sensor AC-powered Operating Table Surgical Light Cholesterol Analysis Device Blood Type Analysis Device, etc.	[Ex.] • Electron • Electron Gauge • Electron • Hearing • Electroc • MRI • Ultrason • Diagnost • X-ray Dia • Central	ic Thermometer ic Blood Pressure ic Endoscope Aid ardiograph ic Diagnostic System ic Imaging Equipment agnostic Equipment	[Ex.] Dialysis Machine Radiation Therapy B Infusion Pump Respirator Glucose Monitoring AED (Automated E Defibrillator) Skin Laser Scanner Electric Surgical Ur Insulin Pump, etc.	g System xternal	[Ex.] Cardiac Pacemaker Video Flexible Angioscope Implantable Infusion Pump Cardiac Electrosurgical Unit Inspection Device with Cardiac Catheter Defibrillator, etc.			
	FDA Classification	Class I General Controls		General Co	ss II ontrols and Controls	_	Class III General Controls and Premarket Approval			
U.S.A.		Medical devices without the pof causing serious injury or lot to the patient or user even i is a defect or malfunction in medical devices	harm f there	Medical devices w of causing injury o patient or user if the malfunction in suc	r harm to the here is a defect or	Medical of causir or death	devices with the possibility g serious injury, disability to the patient or user if a r malfunction occurs in such			

Coverage of those Classes by TAIYO YUDEN Products

Product Series for Medical Devices

*Note: It is prohibited that our products are used in some medical devices such as implantable medical devices even if such medical devices are classified as GHTF Class C (Japan Class III).

N/A

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SMD POWER INDUCTORS (NS SERIES)

AEC-Q200 Grade 3 (we conduct the evaluation at the test condition of Grade 3.)

*Operating environment Temp:-40~85°C



■PART NUMBER

*Operating Temp.: -40~125°C (Including self-generated heat)

space

N	S	Δ	1	0	1	4	5	Т	Δ	1	0	0	М	N	٧	V	/	△=Blank
	1				2			(3		(4)	(5)	(6	7	$\overline{)}$	

(1)Series name

· · · · · · · · · · · · · · · · · · ·	
Code	Series name
NS△	SMD inductor

2Dimensions (L × W × H)

Code	Dimensions (L × W × H) [mm]
10145	10.1 × 10.1 × 4.5
10155	10.1 × 10.1 × 5.5
10165	10.1 × 10.1 × 6.5
12555	12.5 × 12.5 × 5.5
12565	12.5 × 12.5 × 6.5
12575	12.5 × 12.5 × 7.5

3Packaging

O I ackaging	
Code	Packaging
TΔ	Taping

4 Nominal inductance

Code (example)	Nominal inductance [μ H]
1R0	1.0
100	10
101	100

⑤Inductance tolerance

Code	Inductance tolerance
М	±20%
N	±30%

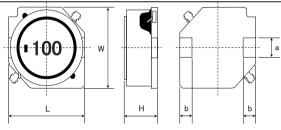
6 Special code

Code	Special code
NΔ	125 type standard
NV	101 type standard

7)Internal code

Code	Internal code
٧	Inductor for Automotive
8	Inductor for Telecommunications infrastructure and Industrial equipment / Medical devices

■STANDARD EXTERNAL DIMENSIONS / MINIMUM QUANTITY



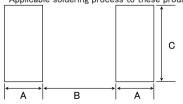
Туре	L	W	Н	а	b	Minimum quantity [pcs]
NS 10145	10.1±0.3	10.1±0.3	4.5±0.35	2.8±0.1	2.0±0.15	2000
113 10143	(0.398 ± 0.012)	(0.398 ± 0.012)	(0.177 ± 0.014)	(0.110 ± 0.004)	(0.079 ± 0.006)	2000
NS 10155	10.1±0.3	10.1±0.3	5.5±0.35	2.8±0.1	2.0±0.15	2000
113 10133	(0.398 ± 0.012)	(0.398 ± 0.012)	(0.217 ± 0.014)	(0.110 ± 0.004)	(0.079 ± 0.006)	2000
NS 10165	10.1 ± 0.3	10.1 ± 0.3	6.5±0.35	2.8±0.1	2.0±0.15	2000
113 10103	(0.398 ± 0.012)	(0.398 ± 0.012)	(0.256 ± 0.014)	(0.110 ± 0.004)	(0.079 ± 0.006)	2000
NS 12555	12.5±0.3	12.5±0.3	5.5±0.35	3.0 ± 0.1	2.0±0.15	2000
NS 12000	(0.492 ± 0.012)	(0.492 ± 0.012)	(0.217 ± 0.014)	(0.118 ± 0.004)	(0.079 ± 0.006)	2000
NS 12565	12.5±0.3	12.5±0.3	6.5±0.35	3.0±0.1	2.0±0.15	2000
113 12303	(0.492 ± 0.012)	(0.492 ± 0.012)	(0.256 ± 0.014)	(0.118 ± 0.004)	(0.079 ± 0.006)	2000
NS 12575	12.5±0.3	12.5±0.3	7.5±0.35	3.0±0.1	2.0±0.15	2000
NO 120/0	(0.492 ± 0.012)	(0.492 ± 0.012)	(0.295 ± 0.014)	(0.118 ± 0.004)	(0.079 ± 0.006)	2000

Unit:mm(inch)

Recommended Land Patterns

Surface Mounting

- •Mounting and soldering conditions should be checked beforehand.
- Applicable soldering process to these products is reflow soldering only.



Type	Α	В	С
NS 10145	2.5	5.6	3.2
NS 10155	2.5	5.6	3.2
NS 10165	2.5	5.6	3.2
NS 12555	2.5	8.6	3.2
NS 12565	2.5	8.6	3.2
NS 12575	2.5	8.6	3.2

Unit:mm



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· All the SMD Power Inductors of the catalog lineup are RoHS compliant.

for High Quality Equipment

- The exchange of individual specifications is necessary depending on your application and/or circuit condition. Please contact TAIYO YUDEN's official sales channel.
- The products are for Telecommunications infrastructure and Industrial equipment and for Medical devices.
- Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications, etc.,
- and please review and approve the product specifications before ordering.
- Please be sure to contact us for further information in advance when the products are used for automotive electronic equipment.

NS 10145 type

	Nominal inductance	DC Peri	DC Resistance	Rated current ※)[A]		Measuring	
Part number	Nominal Inductance [μ H]	Inductance tolerance	$[\Omega](\pm 20\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[kHz]	Note
NS 10145T 1R0NNV8	1.0	±30%	0.0049	12.54	8.90	100	
NS 10145T 1R5NNV8	1.5	±30%	0.0060	10.34	7.99	100	
NS 10145T 2R2NNV8	2.2	±30%	0.0085	8.91	6.64	100	
NS 10145T 3R3NNV8	3.3	±30%	0.0100	7.33	6.10	100	
NS 10145T 4R7NNV8	4.7	±30%	0.0144	6.69	5.03	100	
NS 10145T 5R6NNV8	5.6	±30%	0.0181	5.85	4.45	100	
NS 10145T 6R8NNV8	6.8	±30%	0.0230	5.05	4.22	100	
NS 10145T 100MNV8	10	±20%	0.0270	4.22	3.10	100	
NS 10145T 150MNV8	15	±20%	0.0381	3.44	3.00	100	
NS 10145T 220MNV8	22	±20%	0.0570	2.87	2.30	100	
NS 10145T 330MNV8	33	±20%	0.0880	2.36	1.90	100	
NS 10145T 470MNV8	47	±20%	0.130	2.00	1.50	100	
NS 10145T 680MNV8	68	±20%	0.150	1.66	1.45	100	
NS 10145T 101MNV8	100	±20%	0.230	1.40	1.10	100	
NS 10145T 151MNV8	150	±20%	0.350	1.11	0.86	100	
NS 10145T 221MNV8	220	±20%	0.510	0.91	0.78	100	
NS 10145T 331MNV8	330	±20%	0.700	0.71	0.64	100	
NS 10145T 471MNV8	470	±20%	1.03	0.61	0.52	100	
NS 10145T 681MNV8	680	±20%	1.57	0.50	0.42	100	
NS 10145T 102MNV8	1000	±20%	2.58	0.41	0.32	100	
NS 10145T 152MNV8	1500	±20%	3.70	0.36	0.27	100	

NS 10155 type

WS 10133 type	NS 10153 type						
	Nominal inductance		DC Resistance	Rated curre	nt ※)[A]	Measuring	
Part number	[μ H]	Inductance tolerance	[Ω](±20%)	Saturation current	Temperature rise current	frequency[kHz]	Note
	[μ11]		[32](=2070)	Idc1	Idc2	irequericy[kii2]	
NS 10155T 1R5NNV8	1.5	±30%	0.0060	11.90	8.39	100	
NS 10155T 2R2NNV8	2.2	±30%	0.0072	10.00	7.61	100	
NS 10155T 3R3NNV8	3.3	±30%	0.0097	8.50	6.49	100	
NS 10155T 4R7NNV8	4.7	±30%	0.0112	7.40	6.01	100	
NS 10155T 6R8NNV8	6.8	±30%	0.0159	6.00	4.98	100	
NS 10155T 100MNV8	10	±20%	0.0200	4.49	4.40	100	
NS 10155T 150MNV8	15	±20%	0.0310	4.03	3.40	100	
NS 10155T 220MNV8	22	±20%	0.0430	3.37	2.80	100	

NS 10165 type

	Nominal inductance DC Resist		DO Desistence	Rated curre	nt ※)[A]	Measuring	
Part number	[μ H]	Inductance tolerance	DC Resistance [Ω](±20%)	Saturation current Idc1	Temperature rise current Idc2	frequency[kHz]	Note
NS 10165T 1R5NNV8	1.5	±30%	0.0062	13.60	8.04	100	
NS 10165T 2R2NNV8	2.2	±30%	0.0074	10.80	7.32	100	
NS 10165T 3R3NNV8	3.3	±30%	0.0086	9.30	6.76	100	
NS 10165T 4R7NNV8	4.7	±30%	0.0112	7.70	5.88	100	
NS 10165T 6R8NNV8	6.8	±30%	0.0140	6.00	5.22	100	
NS 10165T 100MNV8	10	±20%	0.0174	5.20	4.66	100	
NS 10165T 150MNV8	15	±20%	0.0280	3.60	3.84	100	
NS 10165T 220MNV8	22	±20%	0.0350	3.10	3.41	100	

- *X) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
- ※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
- * The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

2021

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NS 12555 type

	Nominal inductance		DC Resistance Rated of		nt ※)[A]	Measuring	
Part number	[μ H]	Inductance tolerance	$[\Omega](\pm 20\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[kHz]	Note
NS 12555T 6R0NN 8	6.0	±30%	0.0140	5.01	5.60	100	
NS 12555T 100MN 8	10	±20%	0.0175	4.73	5.04	100	
NS 12555T 150MN 8	15	±20%	0.0233	3.89	4.18	100	
NS 12555T 220MN 8	22	±20%	0.0297	3.20	3.81	100	
NS 12555T 330MN 8	33	±20%	0.0415	2.64	3.16	100	
NS 12555T 470MN 8	47	±20%	0.0618	2.23	2.70	100	
NS 12555T 680MN 8	68	±20%	0.0832	1.81	2.14	100	
NS 12555T 101MN 8	100	±20%	0.117	1.53	1.86	100	
NS 12555T 151MN 8	150	±20%	0.215	1.10	1.30	100	
NS 12555T 221MN 8	220	±20%	0.270	1.00	1.18	100	
NS 12555T 331MN 8	330	±20%	0.410	0.82	0.96	100	
NS 12555T 471MN 8	470	±20%	0.520	0.68	0.80	100	
NS 12555T 681MN 8	680	±20%	0.870	0.48	0.61	100	
NS 12555T 102MN 8	1000	±20%	1.44	0.41	0.46	100	
NS 12555T 152MN 8	1500	±20%	1.73	0.40	0.44	100	

NS 12565 type

	M 1 11 1 1		DC Resistance	Rated curre	nt ※)[A]		
Part number	Nominal inductance [μ H]	Inductance tolerance	[Ω](±20%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[kHz]	Note
NS 12565T 2R0NN 8	2.0	±30%	0.0080	13.91	7.60	100	
NS 12565T 4R2NN 8	4.2	±30%	0.0126	9.40	5.91	100	
NS 12565T 7R0NN 8	7.0	±30%	0.0162	7.80	5.21	100	
NS 12565T 100MN 8	10	±20%	0.0199	6.00	4.75	100	
NS 12565T 150MN 8	15	±20%	0.0237	5.60	4.33	100	
NS 12565T 220MN 8	22	±20%	0.0310	4.20	3.91	100	
NS 12565T 330MN 8	33	±20%	0.0390	3.80	3.22	100	
NS 12565T 470MN 8	47	±20%	0.0575	3.34	2.78	100	
NS 12565T 680MN 8	68	±20%	0.0775	2.70	2.30	100	
NS 12565T 101MN 8	100	±20%	0.123	2.23	1.81	100	
NS 12565T 151MN 8	150	±20%	0.173	1.80	1.54	100	
NS 12565T 221MN 8	220	±20%	0.273	1.39	1.18	100	

NS 12575 type

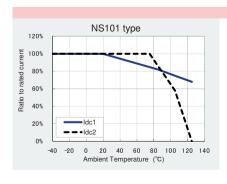
NS 12373 type	Nominal inductance		DO De determe	Rated curre	nt ※)[A]	Manager	
Part number	[μ H]	Inductance tolerance	DC Resistance [Ω](±20%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[kHz]	Note
NS 12575T 1R2NN 8	1.2	±30%	0.0058	18.08	9.15	100	
NS 12575T 2R7NN 8	2.7	±30%	0.0085	13.91	7.69	100	
NS 12575T 3R9NN 8	3.9	±30%	0.0099	12.10	7.38	100	
NS 12575T 5R6NN 8	5.6	±30%	0.0116	10.20	6.36	100	
NS 12575T 6R8NN 8	6.8	±30%	0.0131	9.50	5.84	100	
NS 12575T 100MN 8	10	±20%	0.0156	7.65	5.55	100	
NS 12575T 150MN 8	15	±20%	0.0184	6.30	5.22	100	
NS 12575T 220MN 8	22	±20%	0.0260	5.50	4.05	100	
NS 12575T 330MN 8	33	±20%	0.0390	4.30	3.48	100	
NS 12575T 470MN 8	47	±20%	0.0515	3.60	2.95	100	
NS 12575T 680MN 8	68	±20%	0.0900	2.78	2.10	100	
NS 12575T 101MN 8	100	±20%	0.110	2.50	2.01	100	
NS 12575T 151MN 8	150	±20%	0.161	1.90	1.51	100	
NS 12575T 221MN 8	220	±20%	0.300	1.60	1.10	100	
NS 12575T 102MN 8	1000	±20%	1.170	0.72	0.53	100	

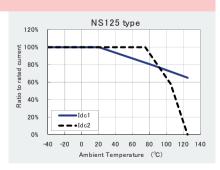
- *X) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
- X) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
- **) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

Derating of Rated Current

NS series

Derating of current is necessary for NS series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.





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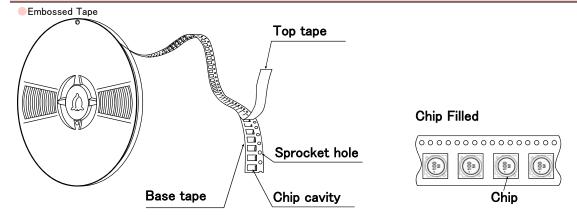
SMD POWER INDUCTORS (NS SERIES)

■PACKAGING

1) Packing Quantity

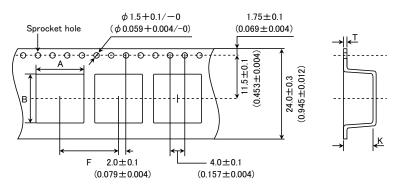
Type	Standard Quantity (1reel) [pcs]	Minimum Quantity [pcs]
Туре	Embossed Tape	Embossed Tape
NS10145	500	2000
NS10155	500	2000
NS10165	500	2000
NS12555	500	2000
NS12565	500	2000
NS12575	500	2000

②Tape Material



3 Taping dimensions

Embossed tape 24mm wide (0.945 inches wide)

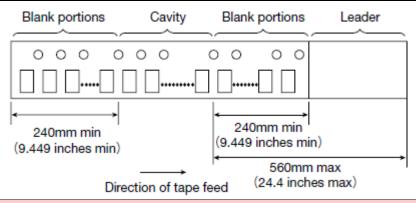


Туре	Chip	cavity	Insertion pitch	Tape th	nickness
Туре	Α	В	F	Т	K
NC1014E	10.5±0.1	10.5±0.1	16.0±0.1	0.4±0.1	5.0±0.1
NS10145	(0.413 ± 0.004)	(0.413 ± 0.004)	(0.630 ± 0.004)	(0.016 ± 0.004)	(0.197 ± 0.004)
NS10155	10.5±0.1	10.5±0.1	16.0±0.1	0.4±0.1	6.0±0.1
NS10133	(0.413 ± 0.004)	(0.413 ± 0.004)	(0.630 ± 0.004)	(0.016 ± 0.004)	(0.236 ± 0.004)
NS10165	10.5±0.1	10.5±0.1	16.0±0.1	0.4±0.1	7.0±0.1
NS10100	(0.413 ± 0.004)	(0.413 ± 0.004)	(0.630 ± 0.004)	(0.016 ± 0.004)	(0.276 ± 0.004)
NS12555	13.0±0.1	13.0±0.1	16.0±0.1	0.4±0.1	6.1±0.1
NS12000	(0.512 ± 0.004)	(0.512 ± 0.004)	(0.630 ± 0.004)	(0.016 ± 0.004)	(0.240 ± 0.004)
NC10E6E	13.0±0.1	13.0±0.1	16.0±0.1	0.4±0.1	7.1±0.1
NS12565	(0.512 ± 0.004)	(0.512 ± 0.004)	(0.630 ± 0.004)	(0.016 ± 0.004)	(0.280 ± 0.004)
NC10575	13.0±0.1	13.0±0.1	16.0±0.1	0.4±0.1	8.0±0.1
NS12575	(0.512 ± 0.004)	(0.512 ± 0.004)	(0.630 ± 0.004)	(0.016 ± 0.004)	(0.315 ± 0.004)

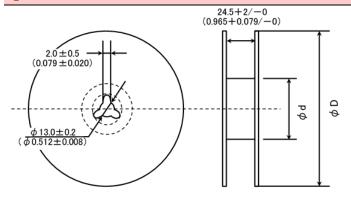
Unit:mm(inch)

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4 Leader and Blank portion



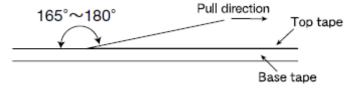
5Reel size



Туре	Reel size (Ref	Reel size (Reference values)				
туре	ϕ D	ϕ d				
NS10145						
NS10155						
NS10165	330±2	100±1				
NS12555	(12.99 ± 0.079)	(3.937 ± 0.039)				
NS12565						
NS12575						
		Unit:mm(inch)				

©Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



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SMD POWER INDUCTORS (NS SERIES)

■RELIABILITY DATA

1. Operating Tempe	rature Range					
Specified Value	NS101, NS125 Type	-40~+125°C (Including self-generated heat)				
Test Methods and Remarks	Including self-generated heat					
2. Storage Tempera	ture Range					
Specified Value	NS101, NS125 Type	_40~+85°C				
Test Methods and Remarks	-5 to 40° C for the product with taping.					
3. Rated current						
Specified Value	NS101, NS125 Type	Within the specified tolerance				
		,				
4. Inductance						
Specified Value	NS101, NS125 Type	Within the specified tolerance				
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 100kHz, 1V					
5. DC Resistance						
Specified Value	NS101, NS125 Type	Within the specified tolerance				
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or	equivalent)				
6. Self resonance fr	requency					
Specified Value	NS101, NS125 Type	_				
7. Temperature cha	racteristic	,				
Specified Value	NS101, NS125 Type	Inductance change : Within ±15%				
NS101, NS125 Type: Measurement of inductance shall be taken at temperature range within $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$. With reference to inductance value at $+20^{\circ}\text{C}$., change rate shall be calculated. Change of maximum inductance deviation in step 1 to 5 Test Methods and Remarks 1 20						
Remarks	2 Minimum operating temperature	-				
	3 20 (Standard temperature)					
	4 Maximum operating temperature					
	5 20					

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8. Resistance to flexure of substrate NS101, NS125 Type Specified Value No damage The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm. Test board size : 100 × 40 × 1.0 Test board material : glass epoxy-resin Solder cream thickness : 0.15 mm(NS101/125Type) Test Methods and Remarks Land dimension Туре В NS101 2.5 5.6 3.2 NS125 2.5 8.6 3.2 В 9. Insulation resistance : between wires NS101, NS125 Type Specified Value 10. Insulation resistance: between wire and core NS101, NS125 Type Specified Value 11. Withstanding voltage: between wire and core Specified Value NS101, NS125 Type 12. Adhesion of terminal electrode Specified Value NS101, NS125 Type Shall not come off PC board The test samples shall be soldered to the test board by the reflow. : 10N to X and Y directions. Applied force Duration : 5s. Test Methods and Solder cream thickness : 0.15mm(NS101/125Type) Remarks 10N, 5s 13. Resistance to vibration Inductance change: Within ±10% Specified Value NS101, NS125 Type No significant abnormality in appearance. The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. Frequency Range 10~55Hz Total Amplitude 1.5mm (May not exceed acceleration 196m/s²) Test Methods and Sweeping Method 10Hz to 55Hz to 10Hz for 1min. Remarks Χ Υ For 2 hours on each X, Y, and Z axis. Time : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. 14. Solderability Specified Value NS101, NS125 Type At least 90% of surface of terminal electrode is covered by new solder. The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table. Flux: Methanol solution containing rosin 25% Test Methods and Solder Temperature 245±5°C Remarks

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15. Resistance to se	15. Resistance to soldering heat						
Specified Value	NS101, NS125 Type	Inductance change: Within ±10% No significant abnormality in appearance.					
Test Methods and Remarks	The test sample shall be exposed to reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times. Test board material : glass epoxy-resin Test board thickness : 1.0mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.						

16. Thermal shock						
Specified Value	NS101, N	NS101, NS125 Type		Inductance change : Within ±10% No significant abnormality in appearance.		
	The test samples shall be soldered to the test board by the ref time by step 1 to step 4 as shown in below table in sequence. Conditions of 1 cycle					
Test Methods and	Step	Temperature (°C)	Duration (min)			
Remarks	1	-40 ± 3	30 ± 3			
Remarks	2	Room temperature	Within 3			
	3	+85±2	30±3			
	4	Room temperature	Within 3			
	Recove	Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.				

17. Damp heat				
Specified Value	L NS101 NS125 Type			Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.			
Remarks	Temperature Humidity	60±2°C 90∼95%RH	-	
	Time	500+24/-0 hour		
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.			

18. Loading under d	amp heat			
Specified Value	NS101, NS125 Type			Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and Remarks	The test samples continuously as sho Temperature Humidity Applied current Time	wn in below table. 60±2°C 90~95%RH Rated current 500+24/-0 hour	ostatic oven se	offlow. It at specified temperature and humidity and applied the rated current and specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and humidity and applied the rated current at specified temperature and the specified temperature at specified temperature and the specified temperature at specified t

19. Low temperature	e life test				
Specified Value	NS101, NS125 Type			Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.	
Test Methods and	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.				
Remarks	Temperature	-40±2°C			
	Time	500+24/-0 hour			
	Recovery : At lea	st 2hrs of recovery under	the standard co	ndition after the test, followed by the measurement within 48hrs.	

20. High temperatur	re life test	
Specified Value	NS101, NS125 Type	_

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21. Loading at high	temperature life test		
Specified Value	NS101, NS125 Type		Inductance change : Within $\pm10\%$ No significant abnormality in appearance.
	The test samples shall be soldered to the test board by the reflow soldering.		
Test Methods and	Temperature	85±2°C	
Remarks	Applied current	Rated current	
	Time	500+24/-0 hour	
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.		

22. Standard condi	tion	
Specified Value	NS101, NS125 Type	Standard test condition: Unless otherwise specified, temperature is $20\pm15^{\circ}\text{C}$ and $65\pm20\%\text{of}$ relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20\pm2^{\circ}\text{C}$ of temperature, $65\pm5\%$ relative humidity. Inductance is in accordance with our measured value.

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SMD POWER INDUCTORS (NR, NS, ES SERIES)

■PRECAUTIONS

1. Circuit Design

◆Operating environment

The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric
appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive
interior applications, etc.

Precautions

Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).

2. PCB Design

♦Land pattern design

Precautions

1. Please refer to a recommended land pattern.

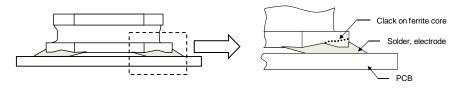
- There is stress, which has been caused by distortion of a PCB, to the inductor. (NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type)
- 3. Please consider the arrangement of parts on a PCB. (NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type)

♦Land pattern design

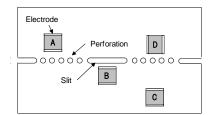
Surface Mounting

- 1. Mounting and soldering conditions should be checked beforehand.
- 2. Applicable soldering process to this products is reflow soldering only.
- 3. Please use the recommended land pattern shown as below. Electrical characteristics and the mounting ability of the product are being considered in the recommended land pattern. If a PCB is designed with other dimensions, defective soldering and stress to a product may occur due to misalignment. The performance of the product may not be brought out. If an adopted land pattern is different from the recommended land pattern, stress to the product will increase. It may cause cracks or defective electrical characteristics of the product. Please conduct validation completely before studying adoption of this product and please judge the pros and cons of adoption of this product with taking on responsibility. (NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type)
- 4. As coefficients of thermal expansion between an inductor and a PCB differs, cracks may occur on a ferrite core when thermal stress is applied to them after mounting an inductor. (Please refer to the drawings below.) Please conduct validation completely before studying adoption of this product and please judge the pros and cons of adoption of this product with taking on responsibility. (NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type)

Technical considerations



5. SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board. (NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type)



A product tends to undergo stress in order "A>C>B≡D".

Please consider the layouts of a product to minimize any stresses.

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3. Considerations for automatic placement Precautions Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. 2. Stress may be applied to a product with a warp or a twist in handling of the product. Please conduct validation completely before studying adoption of this product and please judge the pros and cons of adoption of this product with taking on responsibility. (NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type) Technical considerations ≺Twist>

4. Soldering ◆Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering Precautions heat, soldering etc sufficiently. ◆Recommended conditions for using a soldering iron Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration - 3 seconds or less The soldering iron should not directly touch the inductor. ◆Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. • NRV20/30, NRH24/30, NRS20/30/40/50/60/80, NRM60 Type, NS101/125 Type, EST0645/1040/1060 Type Recommended reflow condition (Pb free solder) ES Series NR, NS Series 5sec max 300 5sec max 300 Technical Peak: 250+5/-0°C Peak: 245°C $\mathsf{Temperature}[\,^{\circ}\mathsf{C}\,]$ [°C] 150~180 150~180 considerations 200 200 $30 \pm 10 sec$ $30 \pm 10 sec$ 100 100 230°C min 230°C min 90±30sec 90±30sec 0 n Heating Time[sec] Heating Time[sec]

5. Cleaning	
Precautions	◆Cleaning conditions 1. Washing by supersonic waves shall be avoided.
Technical considerations	◆Cleaning conditions 1. If washed by supersonic waves, the products might be broken.

6. Handling

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Precautions	 ◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	 ✦ Handling 1. There is a case that a characteristic varies with magnetic influence. ✦ Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ✦ Mechanical considerations 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ✦ Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. ✦ Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

	tions
	♦Storage
	 To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
	Recommended conditions
Precautions	Ambient temperature: $-5 \sim 40^{\circ}$ C
	Humidity: Below 70% RH
	 The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes.
	For this reason, product should be used within 6 months from the time of delivery.
	In case of storage over 6 months, solderability shall be checked before actual usage.
Technical	♦Storage
considerations	Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.